# **Multilayer Ceramic Chip Capacitors**

#### C0603X5R1A104K030BC



#### TDK item description C0603X5R1A104KT\*\*\*\*

		$\mathbf{\lambda}$
Applications	Commercial Grade	~ ~ ~ ~ ~ ~ ~ ~ ~ ~ ~ ~ ~ ~ ~ ~ ~ ~ ~ ~
Feature	General General (Up to 75V)	1
Series	C0603 [EIA 0201]	6
Status	Production (Not Recommended for New Design)	B

	Size
Length(L)	0.60mm ±0.03mm
Width(W)	0.30mm ±0.03mm
Thickness(T)	0.30mm ±0.03mm
Terminal Width(B)	0.10mm Min.
Terminal Spacing(G)	0.20mm Min.
Recommended Land Pattern (PA)	0.25mm to 0.35mm
Recommended Land Pattern (PB)	0.20mm to 0.30mm
Recommended Land Pattern (PC)	0.25mm to 0.35mm

Electrical Characteristics		
Capacitance	100nF ±10%	
Rated Voltage	10VDC	
Temperature Characteristic	X5R(±15%)	
Dissipation Factor (Max.)	10%	
Insulation Resistance (Min.)	1000ΜΩ	

Other		
Soldering Method	Reflow	
AEC-Q200	No	
Packing	Punched (Paper)Taping [180mm Reel]	
Package Quantity	15000pcs	

! Images are for reference only and show exemplary products.

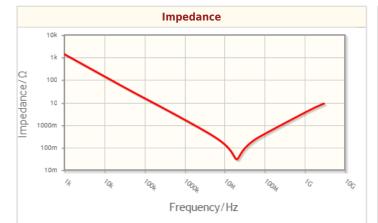
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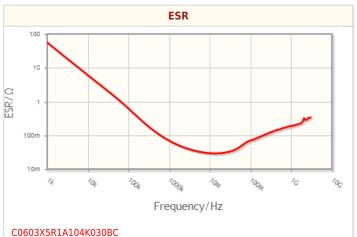
## C0603X5R1A104K030BC



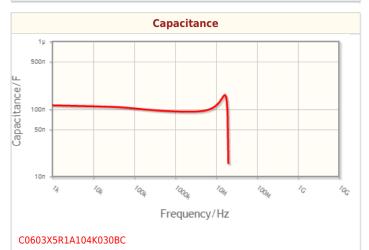


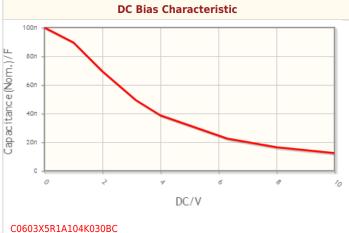


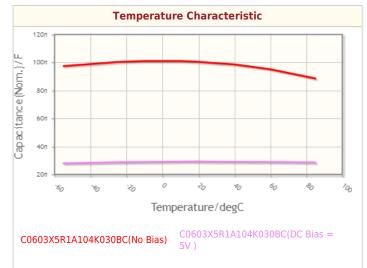
## Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)

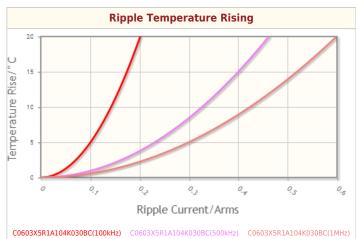


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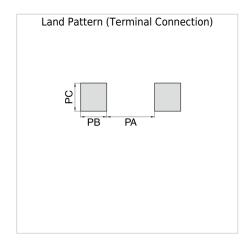
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## Associated Images



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